

Design and Analysis of a Multi-Channel Discriminator Integrated Circuit for Use in
Nuclear Physics Experiments

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ABSTRACT

DESIGN AND ANALYSIS OF A MULTI-CHANNEL DISCRIMINATOR INTEGRATED CIRCUIT FOR USE IN NUCLEAR PHYSICS EXPERIMENTS

by

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This thesis presents the design and simulation of a multi-channel integrated circuit (IC) that will be used in nuclear physics experiments. The chip is being designed as a companion chip for another IC used in particle identification called PSD8C. The IC described in this thesis is used to create precise timing pulses for starting time-to-voltage converters (TVCs) on the PSD8C. These timing pulses are created using a technique called Constant Fraction Discrimination (CFD). Each of the sixteen channels in the IC contains a Nowlin circuit, leading-edge discriminator, zero-cross discriminator, and a one shot circuit to generate the output.

The IC will support input pulse amplitudes between 20 mV and 2V (both positive and negative), and input pulse rise times between 3 nsec and 50 nsec. The IC will feature a programmable output pulse width between 50 nsec and 500 nsec. Most importantly the output pulse firing time variation will be independent of the input amplitude, having a time walk of only 500 psec or less (for input pulse rise time constants of 3 nsec). The IC has been named CFD16C and the design presented is using the AMS-AG 0.35 micron NWEEL process.

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CHAPTER 1

INTRODUCTION

This chapter will introduce the reader to the field of radiation monitoring and describe how custom multi-channel integrated circuits are helping to re-shape this field. The IC described in this thesis, called CFD16C (Constant Fraction Discriminator–16 Channels), is the newest addition to the family of ICs which are being developed by the IC Design Research Laboratory at Southern Illinois University Edwardsville (SIUE) in collaboration with researchers from the Nuclear Reactions Group at Washington University (WUSTL).

1.1 Research Background

The Integrated Circuits Design Research Laboratory at SIUE and the Nuclear Reactions Group at WUSTL have been working (since 2001) on a family of multi-channel custom integrated circuits. The group became interested in developing a family of microchips for use in the detection and measurement of ionizing radiation because: (1) the need for high-density signal processing in the low- and intermediate-energy nuclear physics community is widespread, and (2) no commercial chips were identified that were capable of doing what the researchers wanted, and (3) the scientists deemed it necessary for the experimenter to be in the designer’s seat. The goal is to develop a tool box of circuits, useful for researchers working with radioactive ion beams, which can be composed in different ways to meet the researchers’ evolving needs and desires.

The group’s first success was an analog shape and peak sensing chip with on-board constant-fraction discriminators and sparsified readout. This chip is designed for use with arrays of Si strip detectors of medium scale (with the number of channels ranging from a few hundred to a few thousand) and is known as Heavy-Ion Nuclear Physics–16 Channel (HINP16C).

The second chip, christened Pulse Shape Discrimination–8 Channel(PSD8C), was

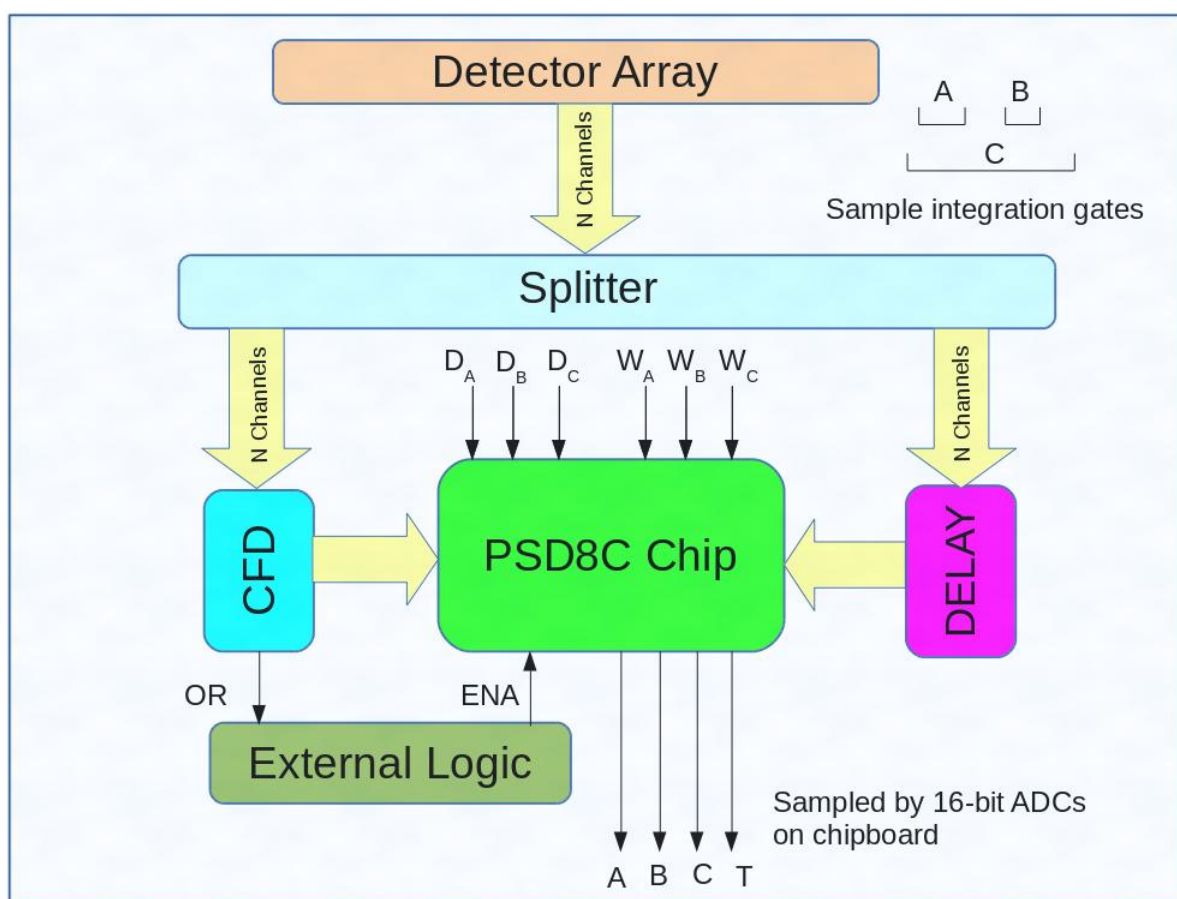


Figure 1.1 shows a typical PSD system using the PSD8C IC. The outputs of a detector array are split in two so that a copy of each signal can be sent to both the CFD circuit and the PSD8C. The signals sent to the PSD8C must be delayed to match the propagation delay of the CFD circuit. The CFD logic signals are ANDed with a global enable signal

to provide channel enables for the PSD8C. For each delayed detector signal (and its associated CFD logic signal), three integrations (called A, B, C) will be performed with start times referenced to the CFD signals. An additional amplitude, T , is produced which is proportional to the time difference between the CFD firing and an external common stop reference, which eliminated the need for VME TDCs.

The integrators' starting time delay (D_A, D_B, D_C) and the integration window widths (W_A, W_B, W_C) are controlled by the user. In Figure 1.1, D_A, D_B, D_C are voltages that are converted to times on-chip, along with the widths W_A, W_B, W_C .

1.2 PSD8C IC

Our PSD8C chip greatly simplifies the pulse-processing electronics needed for large arrays of scintillation detectors. Each channel (see Figure 1.2) possesses 3 sub-channels. The sub-channels are referred to as A, B, and C. A sub-channel consists of an integrator and a gate generator. External control voltages (DX, WX) determine the gate delay and the gate width. The structure of a single PSD8C sub-channel is illustrated in Figure 1.3. Because PSD8C employs (user-controlled) multi-region charge integration, particle identification is incorporated into the basic design. Each channel on the chip also contains a TVC that provides relative time information. The pulse height integrals and the relative time are all stored on capacitors and are either reset, after a user-controlled time, or sequentially read out if acquisition of the event is desired (in a manner similar to that of HINP16C).

Features of the first generation PSD8C (Rev. 1) chip include:

- eight independent channels per IC;
- on-chip data sparsification;
- each channel automatically resets itself after a user programmable delay time;

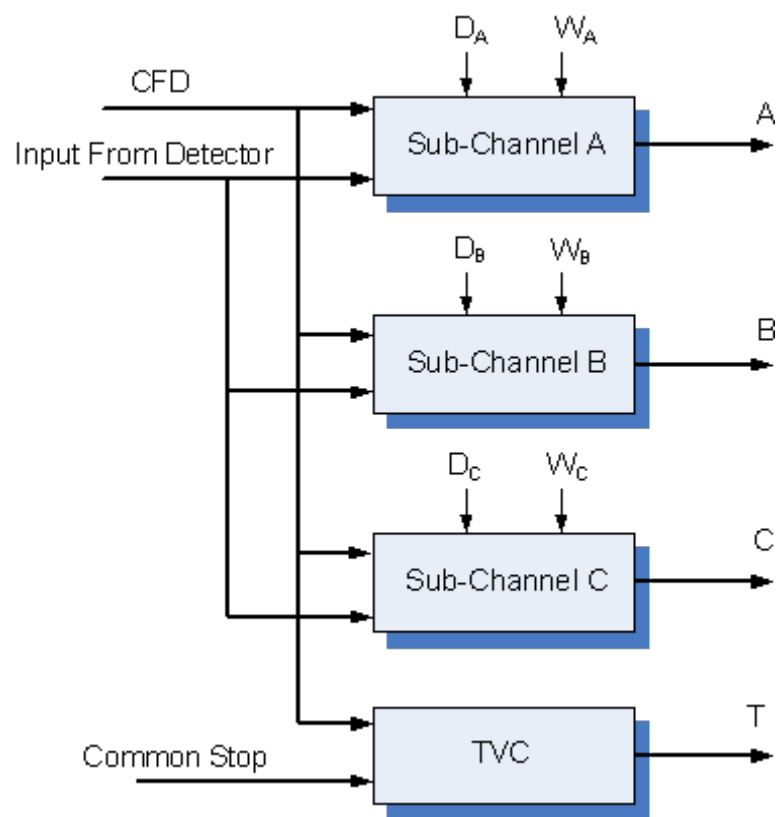


Figure 1.2: PSD Channel

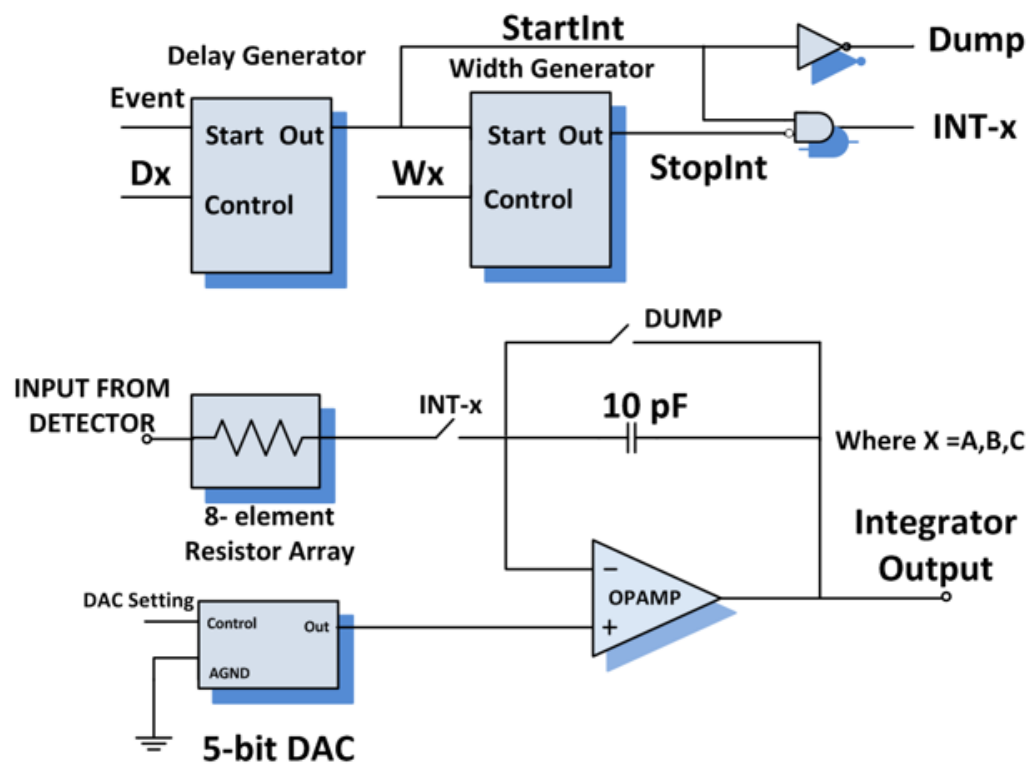
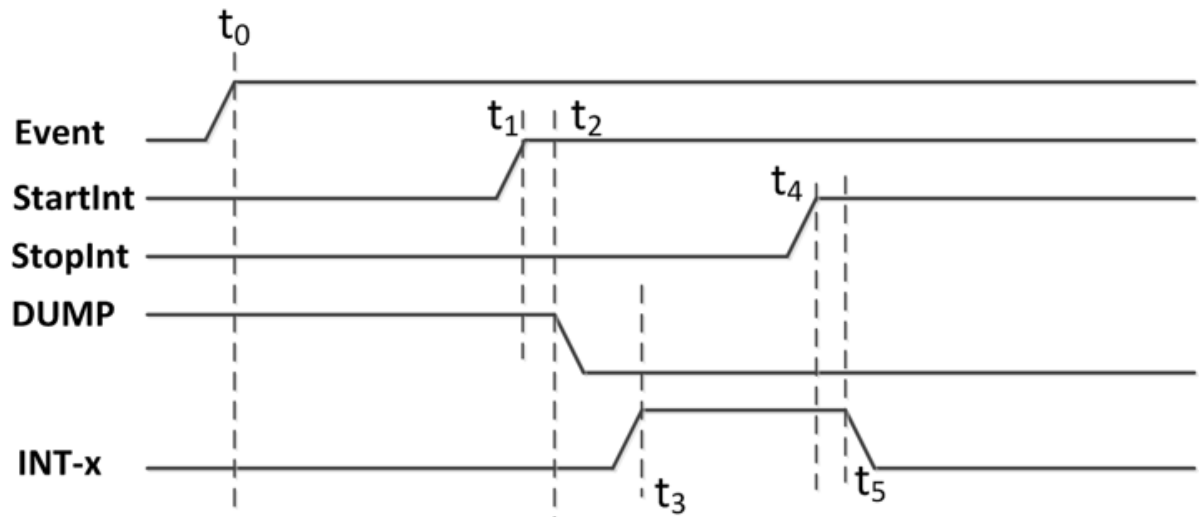


Figure 1.3: PSD Sub-channel.

- three (3) integration regions each with: (a) independent control of time offset (beginning), (b) width (ending) of the integration window, and (c) a menu of eight (8) charging rates;
- each channel possesses a TVC with two time ranges: 500 ns and 2 ms;
- three triggering modes;
- fast logical OR-gate and an analog multiplicity output to aid in trigger decisions;
- two power modes to facilitate use with fast and slow detectors and to thus allow for a more modest power budget for the latter;
- and CFD circuits are not on-chip so as to provide greater flexibility.

PSD8C is described in detail in [Proctor, 2007] and [Hall, 2007]. PSD8C is 2.25 by 5.7 mm^2 and is packaged in a 14 by 14 mm^2 , 128 lead thin quad flat pack. Power consumption is 65 mW (low-bias mode) and 150 mW (high-bias mode). A second version (Rev. 2) of PSD8C was submitted for fabrication in May 2010. Rev. 2 attempts to correct several minor problems. First, the TVC circuit could inadvertently be re-started. In Rev. 2, once the rising edge of the "common stop" signal is detected, the TVC cannot re-start until the channel is reset. Second, undesirable temperature dependence ($1 \frac{nsec}{^\circ C}$) in the TVC circuit was identified and traced to the local channel buffer. The buffer was redesigned, and the TVC temperature sensitivity has been greatly reduced ($5 \frac{psec}{^\circ C}$ in the 500 nsec mode, $40 \frac{psec}{^\circ C}$ in the 2 msec mode). Third, some TVC crosstalk issues were identified and remedied. Fourth, additional shielding was added to the integrator circuits. Finally, at the system level, the chip-boards (printed-circuit boards) were redesigned to include on-board analog to digital converters, or ADCs. (one for each of the chip's analog output pulse trains).

(Still need to talk about enhancements that were made on PSD4)

1.3 Need for an Integrated Circuit

While not including the timing circuits on PSD made it more flexible, those circuits are needed. Currently, a large complex board with many ICs produce the timing signals required by the PSD chip. This thesis describes the design of multi-channel integrated circuit which can generate the timing signals for a pair of PSD chips.

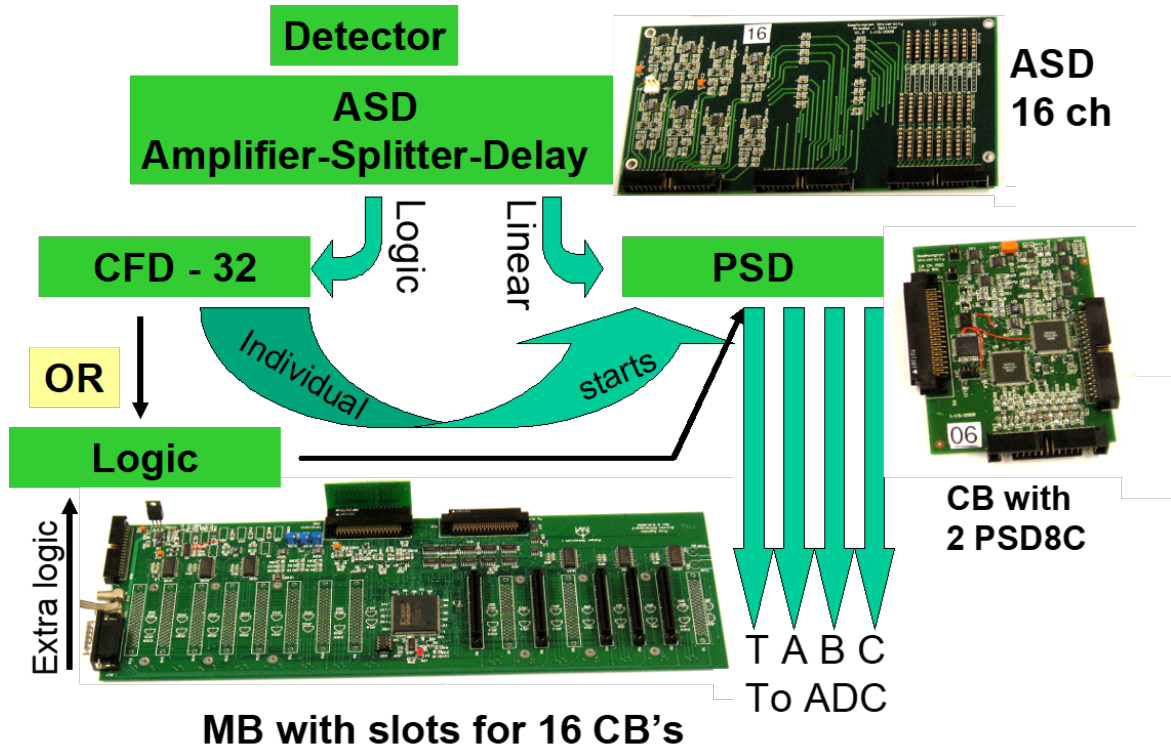


Figure 1.4: PSD system using board-level CFD electronics

1.4 Sample Applications

To focus the reader's attention on what would be possible with the PSD chip complemented by the CFD chip described in this thesis, consider a highly granular discrete element array for neutron detection using the recently developed inorganic [B.S. Budden, 2015] and plastic [N. Zaitseva, 2012] scintillators with PSD. Such a large array would open the n-rich side up to the kind of high-precision work the Washington University group has done

on the p-rich side. (The existing work on the neutron-rich side, done at high energy and with detectors such as MONA-LISA [T. Baumanna, 2005], while providing provocative data on such cases as ^{16}Be [A. Spyrou, 2012] and ^{26}O [Kohley Z., 2015], sufferer for poor statistics and, compared to the proton-rich side, poor resolution.) An array to be deployed at low (reaccelerated beam) energies with thousands of optically isolated PSD elements made from the new generation of plastics, would revolutionize the study of multiple n-decay from what are generally high-isospin states. (The problem of detector-to-detector scattering cross-talk can also be improved with discrete pixilation rather than using large bars by corrugating the detectors in the same way as the conventional discrete array DEMON has [I. Tilquin, 1995]).

While we are enamored with the above idea, it is premature to propose such an array before the ground-work for scalable timing electronics, as we describe in this thesis, is successfully completed. (In fact the coupling of the scintillator from Eljen to the new blue sensitive SiPMs from SensL is simple compared to the development of the scalable electronics.) To this end however, we plan to develop a circuit board using the PSD and CFD chips to process signals from the new generation of PSD-capable plastic scintillators [N. Zaitseva, 2012].

The CFD chip described herein with its programmable Nowlin circuit will allow the WUSTL Nuclear Reactions Group to work with variety of scintillators (LaBr:Ce to CsI:Tl or :Na to standard plastics and, for what might be the most interesting untapped opportunity, the new class of PSD capable plastics [N. Zaitseva, 2012]).

1.5 Object and Scope of Work

The object of this thesis work was to create a multi-channel integrated circuit capable of constant fraction discrimination. This thesis is composed of five chapters. The system level architecture is presented in Chapter 2. Chapter 3 describes the circuit level design of the many sub-circuits that compose the CFD16C. Chapter 4 details the simulated performance

of the CFD16C to show that it performs within the intended design specification. Finally Chapter 5 provides a summary, conclusions, and details future work to be done on the CFD16C.

CHAPTER 2

SYSTEM ARCHITECTURE

This chapter will attempt to describe the CFD16C integrated circuit at the system-level. We will start with a detailed list of system requirements and then will describe the high-level architecture of the IC.

2.1 System Specifications

The success of our group over the past 20 years lies on the close working relationship that the IC Design Research Laboratory at Southern Illinois University Edwardsville (SIUE) has had with the Nuclear Reactions Group at Washington University in St. Louis(WUSTL) led by Dr. Lee Sobotka. The IC group here at SIUE and the Nuclear Reactions Group at WUSTL, after lengthy discussions, drafted the following specifications for the IC described here in this thesis.

- The IC should support 16 detectors.
- It should support analog pulses of both polarities (relative to analog signal ground).
- It should accommodate analog exponentially shaped pulses with rise time constants ranging from 3 nsec to 50 nsec.
- It must exhibit "excellent" walk and jitter characteristics for input pulse amplitudes ranging from 20 mV to 2 V. The adjective "excellent" will be quantified in a later chapter of this thesis.
- Pulse repetition rates up to 1 KHz must be accommodated.
- The discriminator in each of the 16 channels should be of the constant fraction type (CFD). In CFD discriminators an attenuated version of the input is subtracted from

a delayed version of input waveform and the time at which the difference between the two is equal to zero is used to mark the pulse arrival time. This results in output timing signals independent of pulse amplitude.

- Each channel should have a leading-edge threshold.
- While the chip must support signals with rise time constants ranging from 3 nsec to 50 nsec, performance will be optimized for the shorter time constants.
- The output pulse width from a channel should be programmable.
- The IC should operate from a single 3.3 Volt supply.
- Power consumption of the 16 channel IC should not exceed 350 mW *i.e.* 20 mW per channel with 30 mW budgeted for the circuits common to all channels.
- The IC is not to occupy an area greater than roughly 2 mm x 3 mm. The chip should be packaged in a 64-pin plastic package.

2.2 Features

In order to achieve the intended system design specification many of the analog circuitry in the chip is user configurable. Nowlin delay time, leading edge threshold, one-shot pulse width, and lockout times are all able to be configured to the user's needs. Writing to configuration registers is performed using a signal 8-bit wide bus to provide address, mode, and data information. Using the user-controlled *STB* line, address and mode can be presented on the rising edge and then data will be registered into the selected configuration register on the falling edge. Each channel can be individually enabled or disabled as per the needs of the user. Additionally, should it be required, all sixteen channels can be disabled with a single global enable pin available to the user. Finally, a test point is provided to give the user feedback about how some of the digital circuit

elements within the channel are performing. This test point can come from eight different nodes within a specified signal channel.

2.3 System-Level Description

The CFD16C is designed in a 0.35 micron CMOS process. The chip is designed to act as a multi-channel constant fraction discriminator with very low jitter and time walk in the output timing pulse. The chip contains sixteen signal channels that are driven by a detector, and a single common channel that contains circuitry used by all of the signal channels. A system level block diagram of a single signal channel can be seen in Figure 2.1.

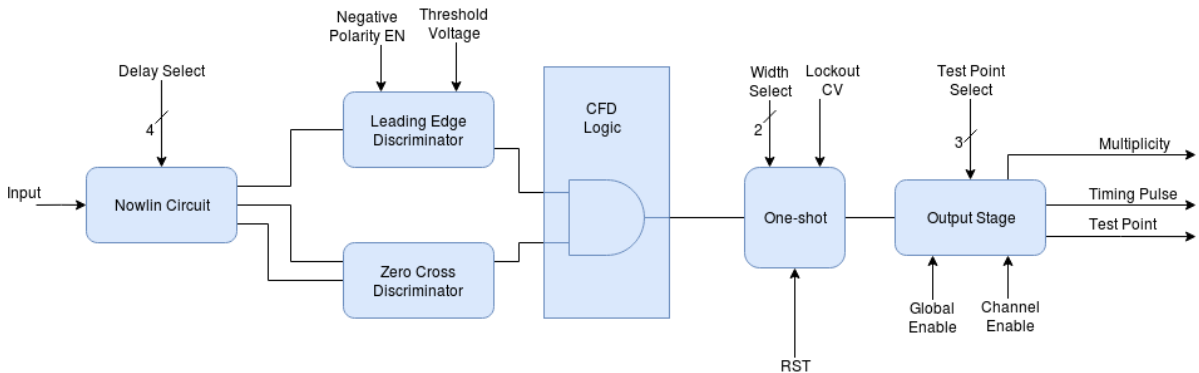


Figure 2.1: System level overview for one channel of the CFD16C

An analog input pulse will arrive at the input stage of the channel in the form of an exponential voltage pulse with a rise time ≈ 10 times faster than its fall time. This stage contains a Nowlin circuit that creates a differential output and a high pass filtered output from the input pulse. The differential output is used as input to a zero crossing discriminator while the high pass filtered output is used as input to a leading edge discriminator. The outputs of the two discriminator channels are ANDed together to provide input to a one shot that creates the output timing pulse. Additional outputs such as a test point and multiplicity output are generated in a final output stage of the channel.

2.3.1 Common Channel

The common channel contains configuration registers to change the performance of the various analog circuits in the signal channels. There are a total of three configuration registers in the common channel and one on the signal channel. These registers can be individually selected and loaded by using a special address and mode scheme. Each channel is assigned a 4-bit address from 0000 to 1111 and each register is assigned a 3-bit mode. To load any specific register the correct mode and address must be provided. A fourth bit of mode, the MSB, is used to select all registers of a given mode regardless of what address is provided. Table 2.1 shows the modes and usage for each of the registers.

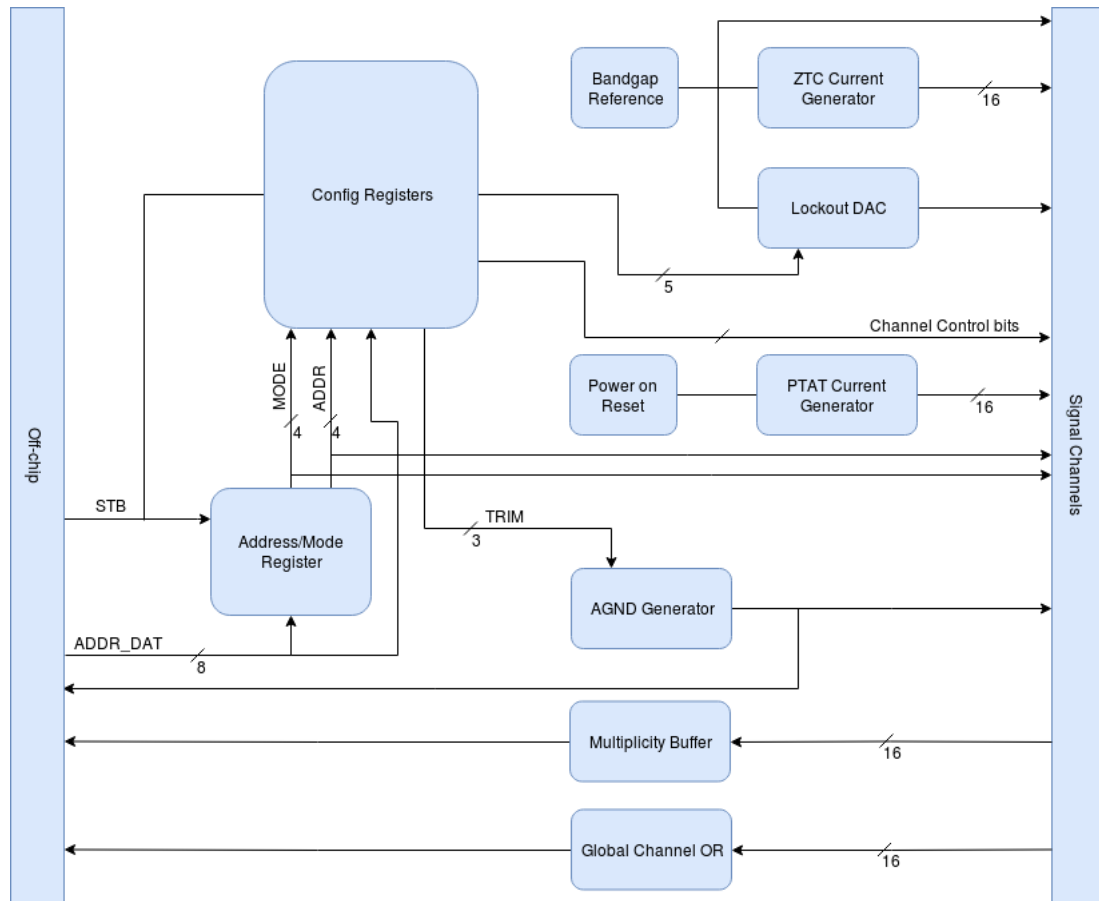


Figure 2.2: System level diagram of the common channel

While the registers need to be provided with data, address, and mode information,

only a single 8-bit bus is used to provide this. On the positive edge of the *STB* input address and mode information are stored in a special purpose register that drives the internal *ADDR* and *MODE* busses (see Figure 2.2). On the negative edge of *STB* data is then stored in all enabled registers.

The common channel also contains biasing circuitry for many of the analog circuits in the signal channels. Bias currents and reference voltages are generated here and distributed to each of the signal channels. More information on these circuits is presented in Chapter 3.

2.3.2 Signal Channel

The input to a signal channel comes from a detector in the form of a pulse with an exponential rise in voltage and an exponential decay. The programmable Nowlin circuit acts as the input stage to the signal channel. The Nowlin circuit is used to create a differential output from this single ended input pulse. One leg of this differential signal is composed of a constant fraction of the input pulse. The other leg of this output is a delayed version of the input pulse. This delay time is determined by an RC time constant that is configurable by changing the value of a programmable capacitor. A high pass filter output is provided by the Nowlin as well, and is used by the leading-edge discriminator circuit.

The differential outputs of the Nowlin circuit are used as inputs to a zero-crossing discriminator (Figure 2.3). This discriminator is created by cascading several amplifiers together and connecting the final output to a high speed comparator. This circuit will provide a digital output that is a logic high (3.3V) when the two differential output voltages from the Nowlin cross the 0V threshold when referenced to analog ground (*AGND*). This will allow the circuit to produce an output independent of the input pulse amplitude [Engel, 2016]. To achieve amplitude independence it is important that the delay time set in the Nowlin circuit is optimal, as seen in Figure 2.4. With a short delay

time there is very little under drive in the output of the final differential amplifier which could prevent the comparator from firing. With too much delay there is not enough slew rate to accommodate the fast timings that are needed.

A DC offset cancellation loop is used to remove the effects of systematic DC offsets. Without this DC compensation loop, the output comparator would be permanently stuck in one state regardless of input from the Nowlin circuit. This same DC cancellation loop is also used in the Leading-edge discriminator.

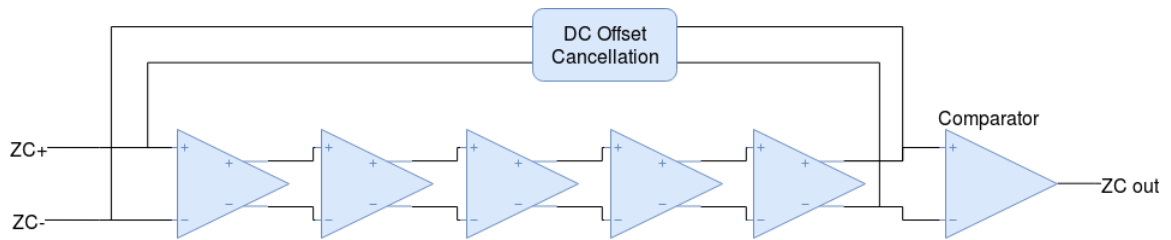


Figure 2.3: Zero cross discriminator with DC cancellation

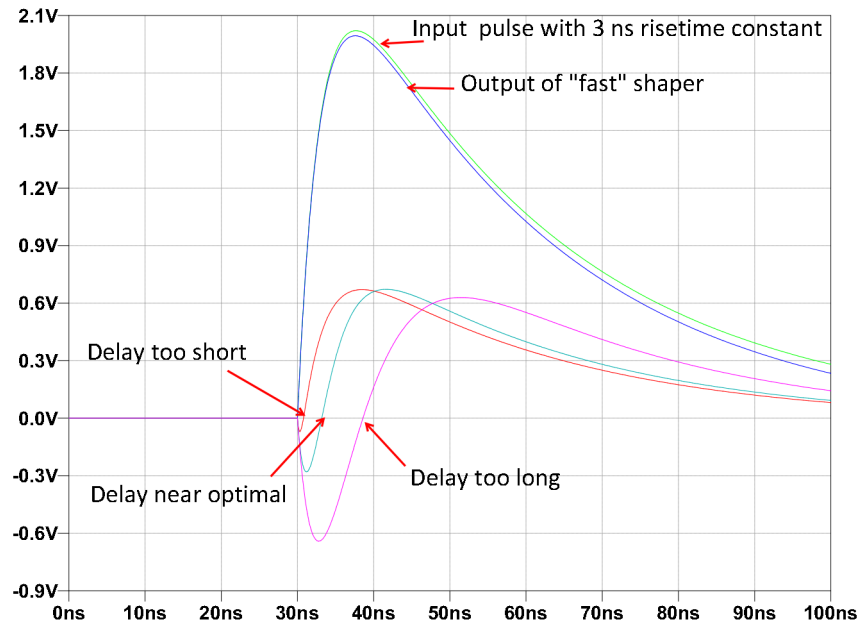


Figure 2.4: Input signal with 3 ns risetime constant showing Nowlin delay effects

The input to the leading-edge discriminator comes from the high-pass filter, or "fast

shaper”, in the Nowlin circuit. The leading-edge discriminator has a user controllable threshold that is compared against the input from the Nowlin circuit. This threshold will be set just above the noise floor, ensuring that the comparator will only fire in response to a real pulse coming off of a detector and not just inherent noise in the circuit. This threshold can be made negative by applying a logic high (3.3V) to the *NEG_POL* input pin. The output of the leading edge discriminator is then used to qualify the zero-cross detector.

Qualified zero-cross discriminator pulse is used as input for a narrow pulse circuit that triggers the one-shot. Figure 2.5 shows this in more detail. The oneshot circuit creates the channel’s output timing pulse. It is provided with a two bit pulse width selection bus that allows the user to configure the output width of this pulse between 50 nsec and 500 nsec. There is another one-shot circuit used to create a lockout period which will prevent the creation of an output timing pulse regardless of the presence of any stimuli from the narrow pulse generator. This lockout time is also user configurable with a control voltage provided by a 5-bit DAC in the common area. The lockout feature can also be completely turned off by the user if desired.

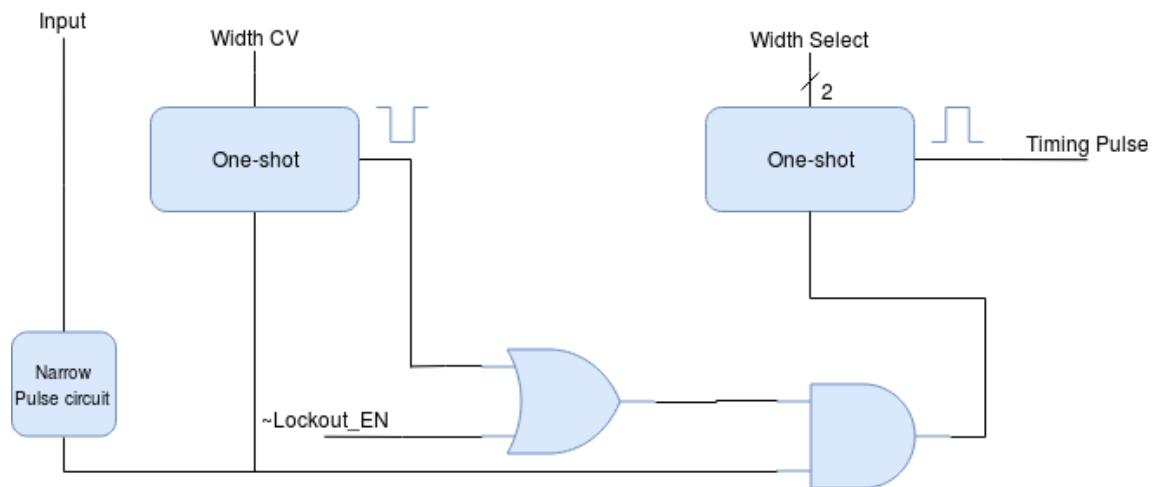


Figure 2.5: System level diagram of one-shot stage

A final output generation stage is used to qualify the timing pulse as well and create

other useful channel outputs. The timing pulse should not be present on the pin of the chip package if the global enable signal is not present, or the channel enable bit is not set. Therefor the timing pulse is ANDed with these two signals before going off-chip as seen in Figure 2.6. The digital test point, multiplicity, and global channel OR outputs are also created in this stage and explained in more detail in the next chapter.

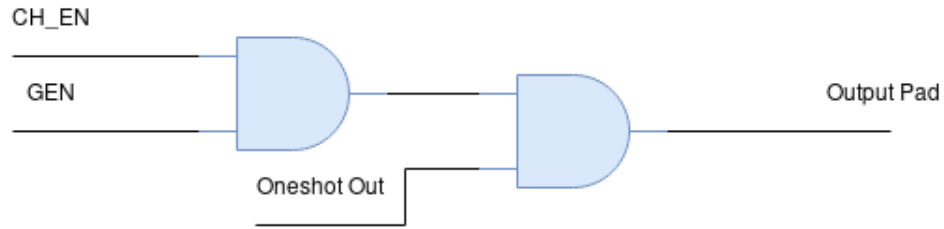


Figure 2.6: Timing pulse output qualification

2.4 Chip Pinout

The CFD16C will be packaged in a 64-pin QFN plastic package. The pinout is detailed in Table 2.2. Pins with no electrical connection to the chip die are labeled as *NC* (no connection).

Mode Bits	Register Size	Bits		
0000	8	7: unused	6-4: Test point signal select	3-0: Programmable capacitor bus
0001	8	7-6: unused	5-3: AGND voltage trim	2-0: oneshot width select
0010	unused			N/A
0011	unused			N/A
0100	unused			N/A
0101	7	6: unused	5: Lockout enable	4-0: Lockout DAC input
0110	7	6: Channel enable	5: Leading edge DAC polarity	4-0: Leading edge DAC input
0111	unused			N/A
1xxx	sends data to all registers of mode 'xxx' regardless of address			

Table 2.1: Register modes and usage

Pin Number	Pin Name	Functionality
1	AIN0	Channel 0 output
2	CH_OR	Global Channel OR
3-4		NC
5*-12	ADDR_DAT7*-ADDR_DAT0	AD7*-0
13-15		NC
16*-22	AIN0*-AIN6	Channel 0*-6 inputs
23	AGND	Analog reference voltage
24	AVSS	Analog circuit ground
25	AVDD	Analog 3.3V supply
26*-34	AIN7*-AIN15	Channel 7*-15 inputs
35-37		NC
38	NEG_POL	Negative Polarity enable
39	AGND_INT_EN	Internal AGND enable
40	RST_L	Low active reset
41	STB	User controlled strobe
42	GEN	Global enable
43		NC
44	MULT	Multiplicity
45	TP	Test point
46-47		NC
48	DOUT15	Channel 15 output
49*-55	DOUT14*-DOUT8	Channel 14*-8 output
56	DVDD	Digital 3.3V supply
57	DGND	Digital circuit ground
58*-64	DOUT7*-DOUT1	Channel 7*-1 output
* used to indicate mapping between pin number and bit/channel number		

Table 2.2: Pinout of CFD16C

CHAPTER 3

ELECTRICAL LEVEL DESIGN

3.1 Fabrication Process

The IC described in this thesis will be fabricated in the AMS-AG 0.35 micron NWELL process. The process supports two poly and 4 metal layers. Double poly capacitors, BJTs, and a high-resistance layer are all available to the designer. NFET device properties are given in Table 3.1 while PFET device properties are available in Table 3.2.

Threshold Voltage	V_{TN}	0.5 V
Transconductance Parameter	K_{PN}	$170 \frac{\mu A}{V^2}$
Bulk Modulation Factor	γ_N	$0.6 V^{\frac{1}{2}}$
Early Voltage per Unit Length	V_{EN}	$21.1 \frac{V}{\mu m}$
Gate Oxide Thickness	t_{ox}	7.6 nm
Gate Oxide Capacitance per Unit Area	C_{ox}	$4.5 \frac{fF}{\mu m^2}$
Threshold Voltage Matching Coefficient	A_{VTN}	$9.4 \text{ mV} \cdot \mu m$
Transconductance Matching Coefficient	A_{KPN}	$0.7 \% \cdot \mu m$

Table 3.1: NMOS Parameters

3.2 Common Channel

The CFD16C is composed of sixteen signal channels and a single larger common channel. As the name implies, the common channel contains configuration and biasing circuitry that is common to all of the signal channels. These include a power on reset circuit, signal ground generator, bandgap reference, and bias current generators.

Threshold Voltage	V_{TP}	-0.7 V
Transconductance Parameter	K_{PP}	$60 \frac{\mu A}{V^2}$
Bulk Modulation Factor	γ_P	$0.4 V^{\frac{1}{2}}$
Early Voltage per Unit Length	V_{EP}	$17.7 \frac{V}{\mu m}$
Gate Oxide Thickness	t_{ox}	7.6 nm
Gate Oxide Capacitance per Unit Area	C_{ox}	$4.5 \frac{fF}{\mu m^2}$
Threshold Voltage Matching Coefficient	A_{VTP}	$14.5 \text{ mV} \cdot \mu m$
Transconductance Matching Coefficient	A_{KPP}	$1.0 \% \cdot \mu m$

Table 3.2: PMOS Parameters

3.2.1 Configuration registers

There are three registers in the common channel as well as one in each of the signal channels. These registers were made using digital standard cells provided in the AMS design kit. The registers are D-registers with an enable input. The enable signal is active when a specified register's address and mode has been selected. A single 8-bit wide bus is used to present address, mode, and data to each of the registers. An 8-bit register in the common channel will register *ADDR* and *MODE* on the rising edge of *STB*, with *ADDR* being in the upper four bits. The 8-bits of data are then registered on the falling edge of *STB*. This decoding topology can be seen in Figure 3.1.

The *ADDR* and *MODE* bits are compared against a hard coded value using the XOR and NOR gates. The hard coded values will be set to match the address of the channel the register is in, as well as the mode that should select the specific register. The *ADDR* decoder circuit is then ORed with the MSB of *MODE* so that all registers of a given mode can be selected if the global mode bit is set.

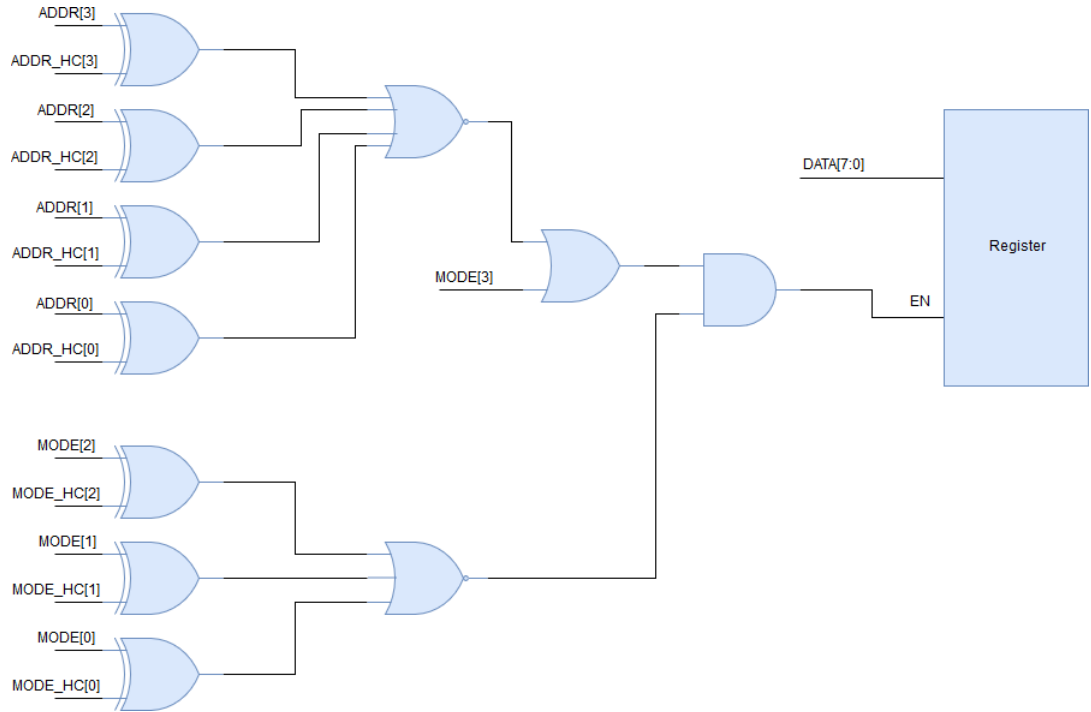


Figure 3.1: Register address and mode decoding

3.2.2 Power on reset circuit

A power on reset circuit is used to start the PTAT bias current generator circuit. The POR circuit was used from the provided analog cells library with the AMS design kit. When power is applied to the CFD16C, the power on reset (POR) circuit generates a single low active reset pulse. This reset pulse is guaranteed to be at least $2 \mu\text{sec}$ long. The POR signal pulse is used to start the PTAT current reference. This PTAT current reference circuit can converge on a $11.5 \mu\text{A}$ or 0 A output current when the CFD16C first receives power, but the 0 A solution is not useful. This long reset pulse guarantees that the PTAT current generator will start correctly and provide an $11.5 \mu\text{A}$ bias current.

3.2.3 Signal ground generator

In each of the signal channels the analog input circuitry is all referenced to a separate signal ground. This signal ground, called *AGND*, must be at a potential half way between

AVDD and *AVSS*. An analog ground generator circuit was provided in an analog cell library from AMS. The signal ground generator circuit can be trimmed to a specific voltage using three trim bits. The signal ground generator has a nominal reference voltage of 1.63 V and can be trimmed by ± 250 mV.

3.2.4 Bandgap voltage reference

A bandgap voltage reference is a circuit that provides a temperature and power supply independent voltage [Allen, 2012]. The bandgap voltage reference used in this design was provided in an analog cells library, and is a known working design. The bandgap voltage reference is used to provide a 1.2 V reference point that is independent of temperature or power supply noise. The bandgap voltage is created by generating a PTAT series resistor and a diode-connected parasitic bipolar PNP transistor [Allen, 2012]. The PTAT current has a positive temperature coefficient while the PNP transistor has a negative temperature coefficient creating a nodal voltage with a temperature coefficient of only $-87 \frac{\mu V}{^\circ C}$ as can be seen in Figure 3.2.

This bandgap topology produces an output voltage of $\approx 1.2V$ with near zero temperature independence. The bandgap reference is further filtered by an RC lowpass filter before being used by any other circuits. This is mostly due to the sensitivity of the circuits that use the bandgap reference to noise, rather than an inherently noisy bandgap reference.

3.2.5 PTAT current reference

A PTAT current reference was used from the analog cells library provided by AMS. This current reference produces a bias current between $7.3 \mu A$ and $17.8 \mu A$ with a nominal value of $11.5 \mu A$. This bias current is proportional to absolute temperature and is used to bias all of the amplifiers on the chip. A weakly or moderately inverted FET has a transconductance linearly proportional to bias current but inversely proportional

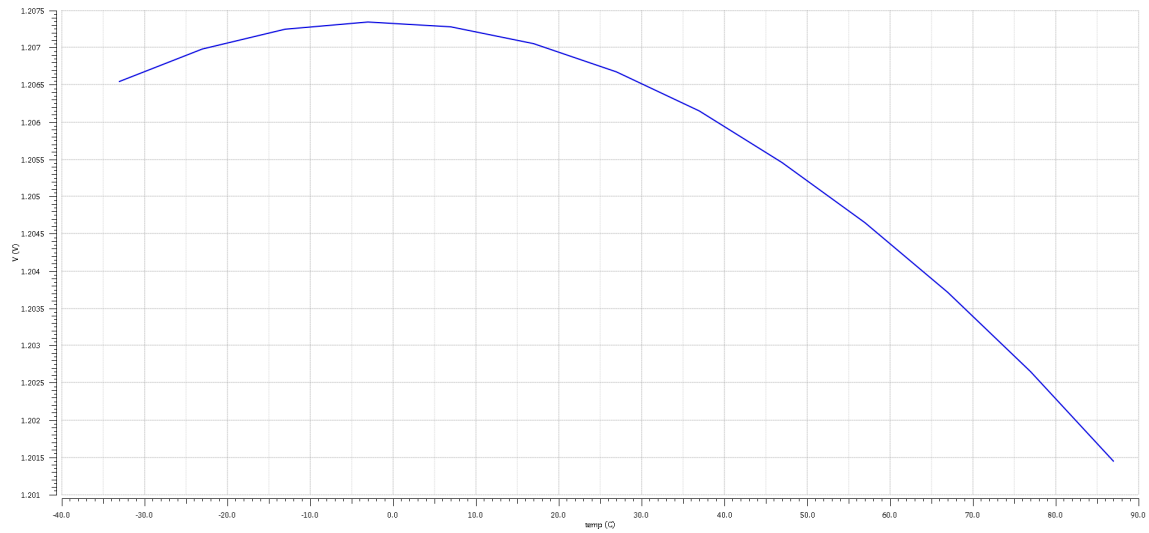


Figure 3.2: Bandgap temperature dependence.

to absolute temperature. Thus by using PTAT currents for the moderately inverted FETs in the amplifier designs, the transconductance of the FETs becomes independent of temperature [Allen, 2012]. Figure 3.3 shows the temperature dependence of the PTAT current reference circuit.

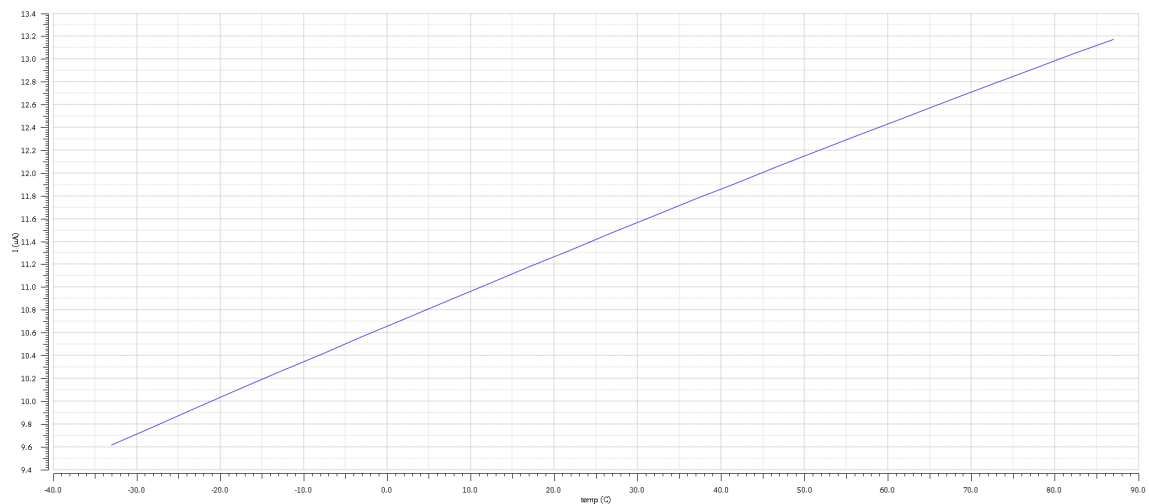


Figure 3.3: PTAT current reference temperature dependence.

3.2.6 Zero-tempco current reference

In order to function correctly, some of the circuitry in the signal channel needs to be biased with a current that has no temperature dependence. This zero temperature coefficient (ZTC) current was generated using an opamp circuit shown in Figure 3.4. In this circuit, the temperature independent bandgap voltage is applied to the inverting terminal of an opamp. The output of the opamp connects to the gate of a PFET whose drain is connected to a zero temperature coefficient 100 k Ω resistor. A feedback connection to the non-inverting terminal of the opamp is made to the drain of the PFET as well.

Because of this feedback connection, the opamp will drive the gate of the PFET to a voltage that ensures there is no potential difference between the inverting and non-inverting terminals of the opamp. This means the voltage drop across the ZTC resistor has to be equal to the bandgap voltage and so the current through the PFET has to be 12 μ A. This ZTC current reference produces a current with a temperature dependence of only 2.07 $\frac{nA}{^{\circ}C}$ as seen in Figure 3.5.

The ZTC resistor is made from a resistor with positive temperature coefficient (rpoly2), and one that has a negative temperature coefficient (rpolyh). The ratio to achieve temperature independence in this process is ≈ 0.56 rpoly2 to 0.44 rpolyh. Since a 12 μ A ZTC current is desired, a 100 k Ω resistor was made using a 56 k Ω rpoly2 resistor and a 44 k Ω rpolyh resistor. This ZTC current is replicated using 17 current mirrors to provide one for each channel, as well as one for the lockout DAC in the common channel. The ZTC currents are used to give the DAC circuits an output that doesn't depend on temperature.

3.2.7 Lockout DAC

It is desirable to prevent the one-shot circuit in the signal channels from firing for a set amount of time after it has already fired. The length of this lockout time may need to

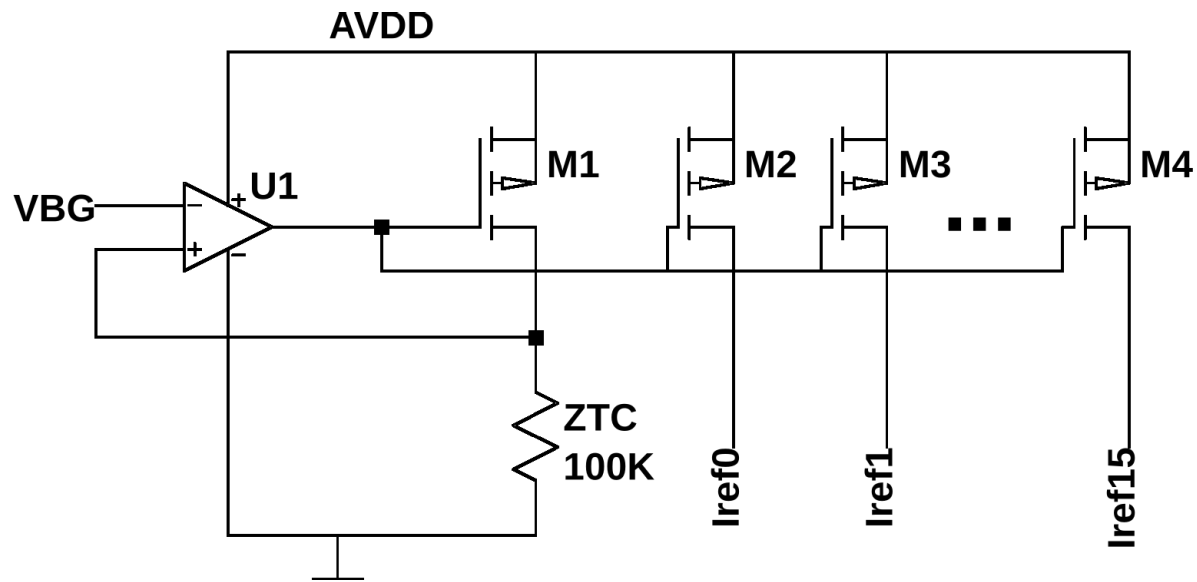


Figure 3.4: Zero temperature coefficient current generator.

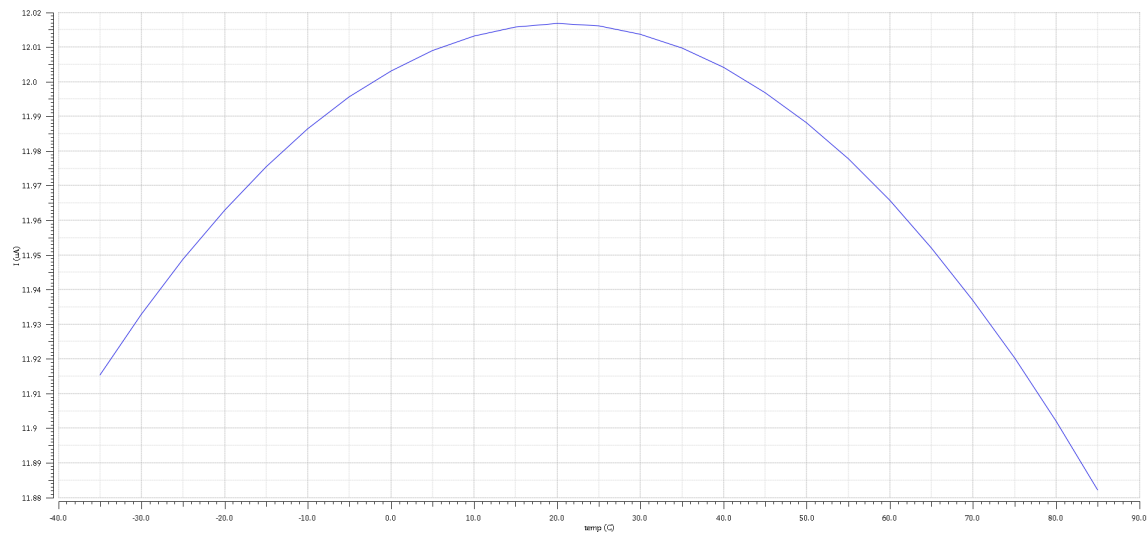


Figure 3.5: Zero temperature coefficient current temperature dependence.

change depending on the nature of the experiment. To do this, a lockout time can be set that is proportional to the voltage at the output of a 6-bit digital to analog converter (DAC).

The DAC itself is implemented as a current scaling DAC using an R2R ladder topology that makes use of MOSFETs as resistors. A ZTC current is used as the input to the DAC. The R2R ladder equally divides the input current in half and uses this divisor current as the input to the next stage of the DAC, as seen in Figure 3.6. The other half of the current is mirrored using a cascode current mirror to create part of the output current of the DAC (Figure 3.7). The use of a cascode current mirror an extremely high output impedance of $r_{ds7} \cdot g_{m7} \cdot r_{ds6}$. A terminator circuit is used to ensure the current splits in half for the last stage (Stage0).

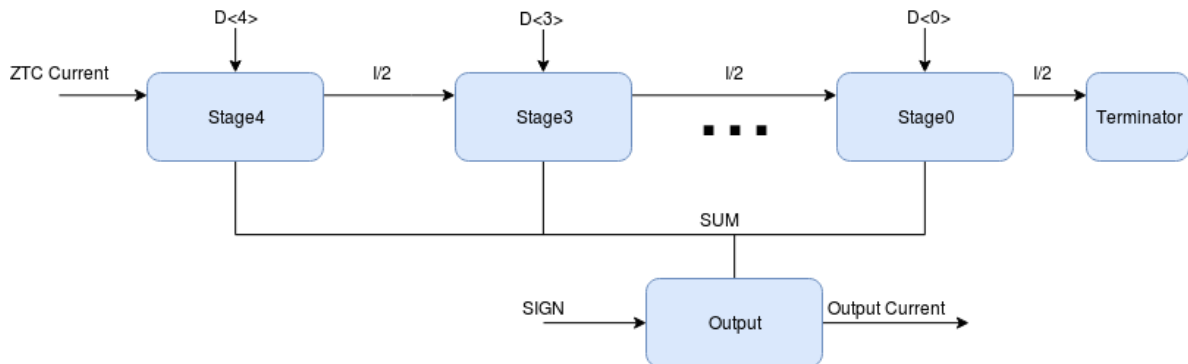
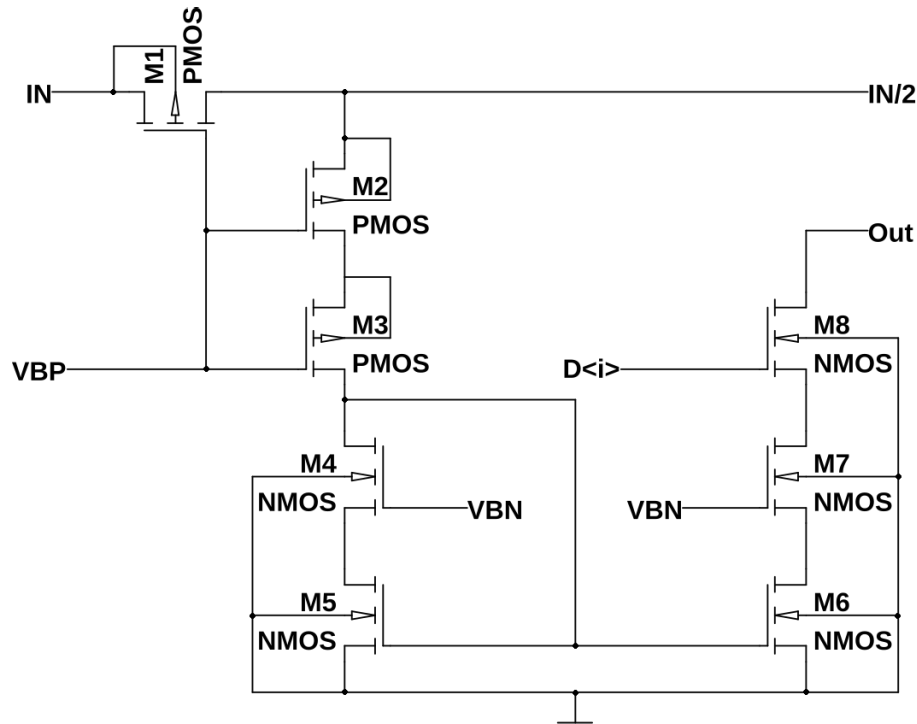


Figure 3.6: 6-bit bipolar DAC

The NFET $M8$ in Figure 3.7 acts as a switch to only allow current to flow when the control bit, $D_{j\hat{i}\hat{j}}$, is a logic 1. The currents are summed up and mirrored with another cascode current mirror in a final output stage of the DAC (Figure 3.8). Either a PFET current mirror or NFET current mirror will be used depending on the sign bit. If the sign bit is high, meaning negative polarity is enabled, then the NFET current mirror will sink current from the DAC output. Conversely, if the sign bit is high, then the PFET current mirror sources current to the output.



3.2.8 Multiplicity output buffer

One of the outputs of the CFD16C is an analog voltage that is proportional to the number of channels that have fired. To create this output each of the signal channels outputs a copy of the PTAT current but only when the channel has fired. All of these PTAT currents are summed up using a resistor to create a voltage. However, it is necessary to buffer this output voltage before sending it off chip. For this a source follower output buffer is used to present a high input impedance, but low output impedance of $\frac{1}{g_{mM_2}}$.

The source follower circuit, shown in Figure 3.9, is biased with a 1 mA current using resistor R1. The signal channel multiplicity currents are summed up using R2 creating an

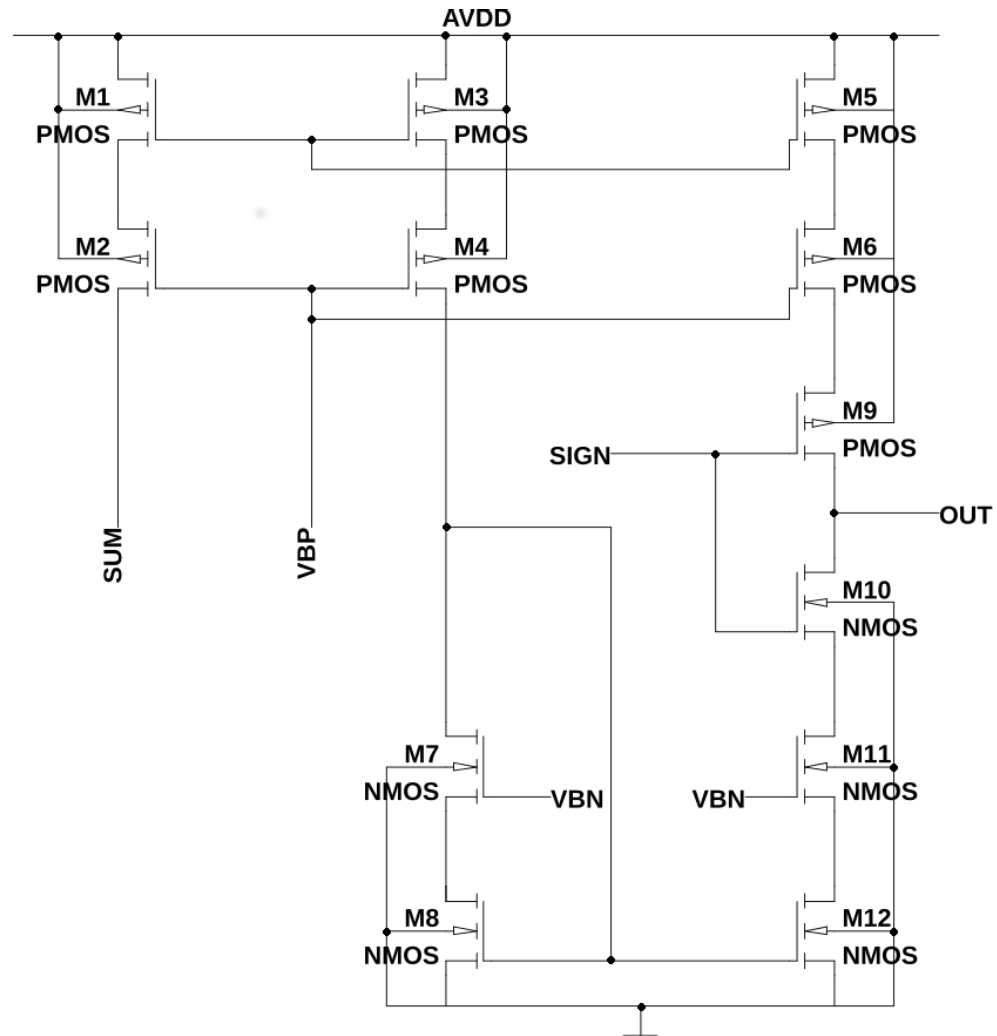


Figure 3.8: DAC output current stage

output voltage on the source of M3. This output voltage is 1.15 V when no channels have fired and 2.7 V when all sixteen channels have fired.

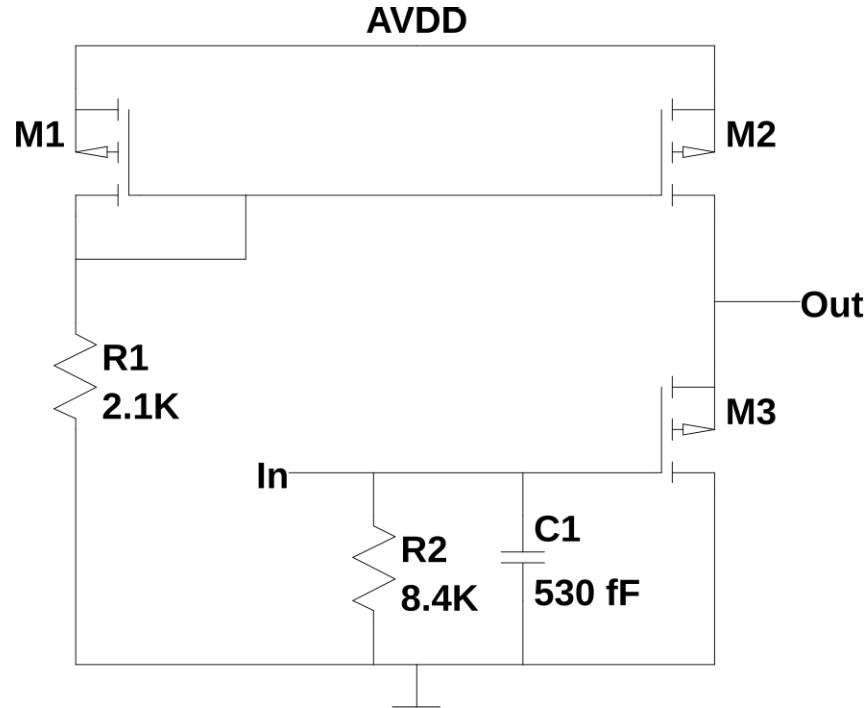


Figure 3.9: Multiplicity output buffer.

3.3 Signal Channel

The CFD16C is made up of sixteen signal channels capable of producing a precise output pulse. Each of the signal channels is identical but contain configurable analog blocks that can be changed on a per channel basis. The signal channel consists of a Nowlin circuit, leading-edge detector circuit, zero-crossing detector circuit, a one-shot circuit, and an output generation circuit.

3.3.1 Programmable Nowlin circuit

The Nowlin circuit is used at the input stage of each of the signal channels and is shown in Figure 3.10. The Nowlin circuit turns a single ended input pulse into a differential signal for use in the zero crossing discriminator. This is achieved by taking a fraction,

in this case $\frac{2}{3}$, of the input voltage using a resistor voltage divider (ZC-). The other leg (ZC+) of the differential output is a delayed version of the input pulse. The delay comes from resistor R3 in Figure 3.10 and the programmable capacitor C2. This creates a configurable RC time constant to delay the input signal.

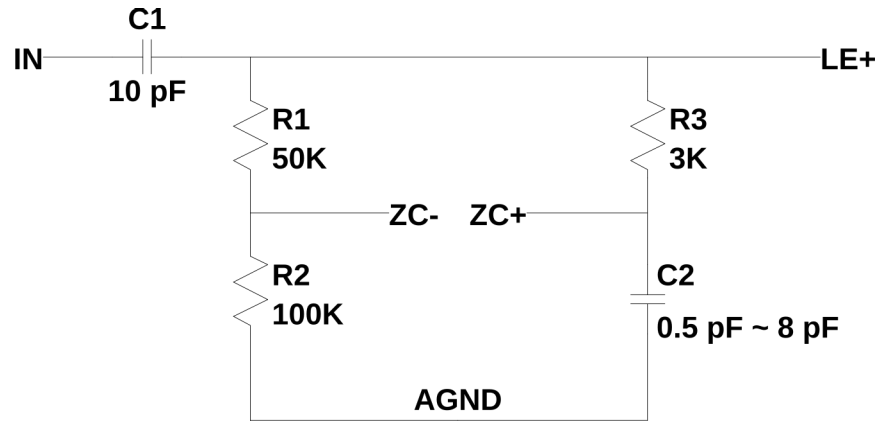


Figure 3.10: Nowlin circuit.

C1 and the series combination of R1 and R2 create a high pass filter whose output is called LE+. The corner frequency of this high pass filter is given by $f_c = \frac{1}{2\pi \cdot (\frac{R1 \cdot R2}{R1 + R2}) \cdot C2} \cong 475kHz$. This high pass filter output is used as input to the leading edge discriminator. The reason for high pass filtering is to remove any low frequency and DC noise present on the input pin as the actual signal pulse will always be a high frequency exponential pulse.

The programmable capacitor (C2) in the Nowlin circuit is created by using switches, in this case transmission gates, to connect individual capacitors in and out of circuit with the Nowlin. Two transmission gates (t-gates) per capacitor are used to accomplish this. The programmable capacitor circuit can be seen in Figure 3.11.

In this configuration when a bit from the programmable capacitor bus is on (ie. 3.3V), the capacitor connects in parallel with C1 from Figure 3.11, adding more capacitance to the ZC+ node in the Nowlin circuit. If the control signal is off (ie. 0V) then the capacitor is shorted out to AGND discharging it and removing capacitance from the ZC+ node. In total there are four of these capacitor circuits, one for each bit of the

programmable capacitor bus. Each capacitor is binary weighted with the following values: 0.5 pF, 1 pF, 2 pF, and 4 pF. This gives a total in circuit capacitance of 8 pF and a minimum in circuit capacitance of 0.5 pF. Table 3.3 shows the bit order of these capacitor elements. Referencing this table shows that the total capacitance at the ZC+ node will be $C_{total} = D \cdot 0.5pF + 0.5pF$ where D is the decimal value of the 4-bit programmable capacitor bus.

The programmable capacitor must be set properly in order to ensure proper operation of the signal channel. Using Table 3.3 an appropriate time constant must be set. This time constant should be chosen such that it is as close as possible to the rise time constant expected from the exponential input pulses coming into the Nowlin circuit.

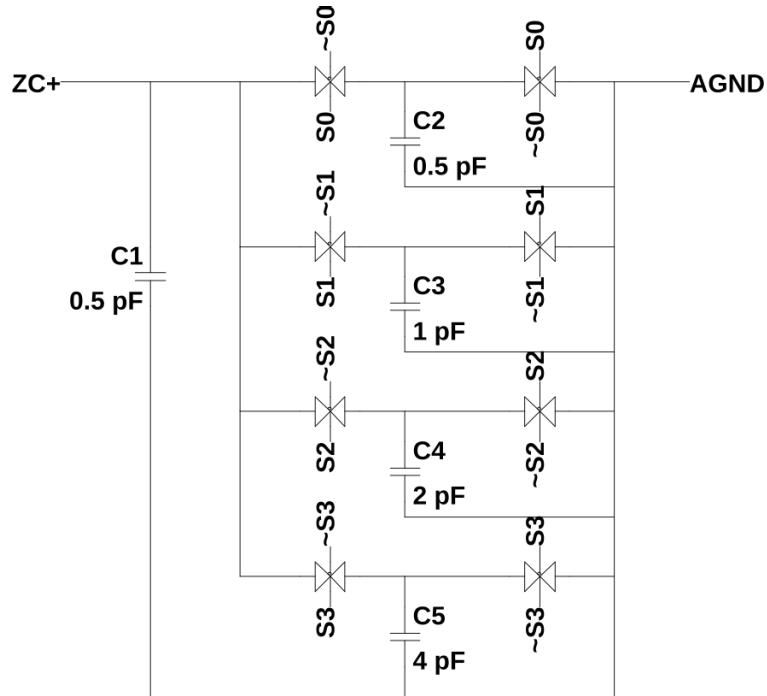


Figure 3.11: Programmable capacitor circuit.

P-CAP Bus	Capacitance	Time Constant
0000	0.5 pF	1.5 nsec
0001	1.0 pF	3.0 nsec
0010	1.5 pF	4.5 nsec
0011	2.0 pF	6.0 nsec
0100	2.5 pF	7.5 nsec
0101	3.0 pF	9.0 nsec
0110	3.5 pF	10.5 nsec
0111	4.0 pF	12.0 nsec
1000	4.5 pF	13.5 nsec
1001	5.0 pF	15.0 nsec
1010	5.5 pF	16.5 nsec
1011	6.0 pF	18.0 nsec
1100	6.5 pF	19.5 nsec
1101	7.0 pF	21.0 nsec
1110	7.5 pF	22.5 nsec
1111	8.0 pF	24.0 nsec

Table 3.3: Programmable capacitor values and time constants.

3.3.2 *Leading-edge detector*

3.3.3 *Zero-cross detector*

3.3.4 *Output one-shot with lockout features*

3.3.5 *Final output generation*

All of the signal channel output are generated in a final output generation stage. In this stage the timing pulse, multiplicity current, global OR, and test point outputs are produced. While the timing pulse is generated in the previous stage by the one-shot circuit, it is necessary to further qualify this output before sending it off chip. Each signal channel can be individually enabled or disabled using a configuration bit, or the whole CFD16C chip can be disabled using a global enable input pin. If the global enable signal or the channel enable bit are not asserted then the timing pulse from the one shot will not be present on the output pin and will not trigger the global OR output.

A number of test point nodes from within the channel can be selected to be routed to a pin on the chip package. These available test point nodes are detailed in Table 3.4. A

multiplexer at the end of each channel controls which test point is used. To prevent all sixteen channels from trying to drive the test point pin at once, a tri-state buffer with enable is used. This enable signal will only be active for the channel whose address is currently selected on the *ADDR* bus, and all other channels will have their test point outputs put into a high impedance state.

Test Point Sel	Test Point Node
000	AVSS
001	lockout pulse
010	leading edge detector pulse
011	oneshot input
100	RST comparator*
101	oneshot pulse
110	zero crossing detector pulse
111	lockout oneshot input*

Table 3.4: Test point multiplexer outputs

The multiplicity current is produced in response to the timing pulse output firing. Once the timing pulse has fired and been qualified, a PFET switch is turned on and allows a copy of the PTAT current to be sourced to the multiplicity buffer in the common channel. All of the channel multiplicity current output are sourced to the same node so that the voltage across the resistor in the multiplicity buffer will be determined by the sum of all of the currents from the fired channels.

The global OR signal is produced by the timing pulse as well. This output is generated using a pseudo-NMOS NOR gate. As shown in Figure 3.12, in a pseudo-NMOS NOR gate a PFET acts as a pullup for parallel connected NFETs. Thus if any one NFET is turned on then the output node will be pulled to *AVSS*. Each channel contains one of these NFETs with the PFET and a CMOS inverter being in the common channel. This allows for a very fast active high logic OR of all of the channels with reduced complexity since the NOR gate is distributed across all channels (reducing the amount of interconnect needed).

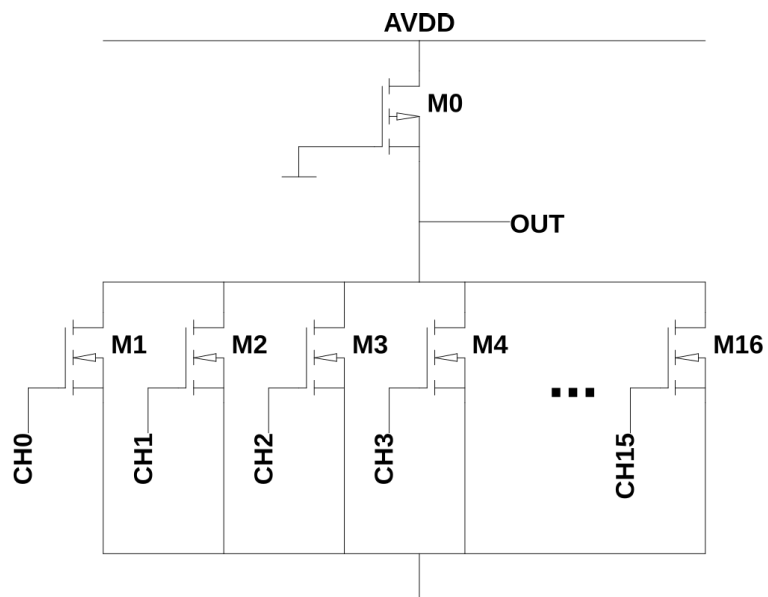


Figure 3.12: Fast pseudo-NMOS NOR

CHAPTER 4

SIMULATION RESULTS

4.1 Verification of Circuits in Common Channel

4.2 Walk Characteristics of CFD Circuit

4.3 Jitter Performance

4.4 Verification of One-Shot

4.5 Performance Characterization of DAC

4.6 Chip-Level Verification

CHAPTER 5

SUMMARY, CONCLUSIONS, AND FUTURE WORK

5.1 Summary5.2 Conclusions5.3 Future Work

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